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# MOSFET - Power, Single N-Channel, TOLL

80 V, 1.7 mΩ, 203 A

# NTBLS1D7N08H

# Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- Lowers Switching Noise/EMI
- These Devices are Pb–Free and are RoHS Compliant Typical Applications
- Power Tools, Battery Operated Vacuums
- UAV/Drones, Material Handling
- BMS/Storage, Home Automation

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	80	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	I <sub>D</sub>	203	А
Current R <sub>θJC</sub> (Notes 1, 3)	Steady	T <sub>C</sub> = 100°C		143	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	167	W
R <sub>θJC</sub> (Note 1)		$T_{C} = 100^{\circ}C$		83	
Continuous Drain		$T_A = 25^{\circ}C$	I <sub>D</sub>	29	А
Current R <sub>θJA</sub> (Notes 1, 2, 3)	Steady	T <sub>A</sub> = 100°C		21	
Power Dissipation	State	$T_A = 25^{\circ}C$	PD	3.5	W
R <sub>θJA</sub> (Notes 1, 2)		$T_A = 100^{\circ}C$		1.7	
Pulsed Drain Current	$T_{\rm C} = 25^{\circ}$	°C, t <sub>p</sub> = 100 μs	I <sub>DM</sub>	1173	А
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	–55 to +175	°C
Source Current (Body Diode)			I <sub>S</sub>	139	А
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 27 \text{ A}$ )			E <sub>AS</sub>	1093.5	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.9	°C/W
Junction-to-Ambient - Steady State (Notes 1, 2)	$R_{\theta JA}$	43	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

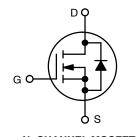
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
80 V	1.7 m $\Omega$ @ 10 V	203 A



N-CHANNEL MOSFET



CASE 100CU

#### MARKING DIAGRAM



1D7N08H = Specific Device Code A = Assembly Location Y = Year WW = Work Week ZZ = Lot Traceability

## ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

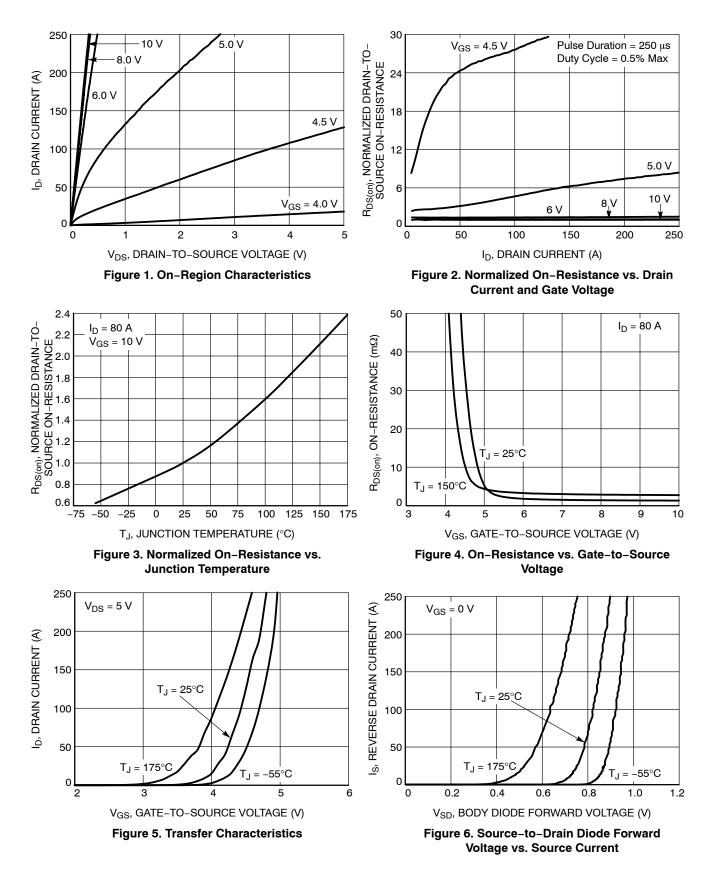
## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		80			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / TJ				57		mV/°C	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V, T_{J} = 25 °C$ $V_{DS} = 80 V T_{J} = 125 °C$				10	μΑ	
						250		
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS}$ = $V_{DS}$ , $I_D$ = 479 $\mu$ A		2.0	2.9	4.0	V	
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>	$I_D = 479 \ \mu A$ , ref to $25^{\circ}C$			-7.3		mV/°C	
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 80 A			1.29	1.7		
		V <sub>GS</sub> = 6 V	I <sub>D</sub> = 43 A		1.76	2.6	mΩ	
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 80 A			271		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE						-	
Input Capacitance	C <sub>ISS</sub>			7675		pF		
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 40 V			1059			
Reverse Transfer Capacitance	C <sub>RSS</sub>				41			
Gate-Resistance	R <sub>G</sub>				0.6			
Total Gate Charge	Q <sub>G(TOT)</sub>				121			
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 40 V; I <sub>D</sub> = 80 A			19		nC	
Gate-to-Source Charge	Q <sub>GS</sub>				32			
Gate-to-Drain Charge	Q <sub>GD</sub>				29			
Plateau Voltage	V <sub>GP</sub>				4.5		V	
Output Charge	Q <sub>OSS</sub>	$V_{GS}$ = 0 V, $V_{DD}$ = 40 V			149		nC	
SWITCHING CHARACTERISTICS (Note 4	1)					-	-	
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 40 V, $I_{D}$ = 80 A, $R_{G}$ = 6 $\Omega$			29		- ns	
Rise Time	t <sub>r</sub>				25			
Turn-Off Delay Time	t <sub>d(OFF)</sub>				89			
Fall Time	t <sub>f</sub>				35			
DRAIN-SOURCE DIODE CHARACTERIS	STICS				-		-	
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V$ , $T_J = 25^{\circ}C$			0.82	1.2		
		$I_{\rm S} = 80 \rm A$	T <sub>J</sub> = 125°C		0.69		V	
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS}$ = 0 V, dIS/dt = 100 A/µs, I <sub>S</sub> = 43 A			73		ns	
Reverse Recovery Charge	Q <sub>RR</sub>				138		nC	

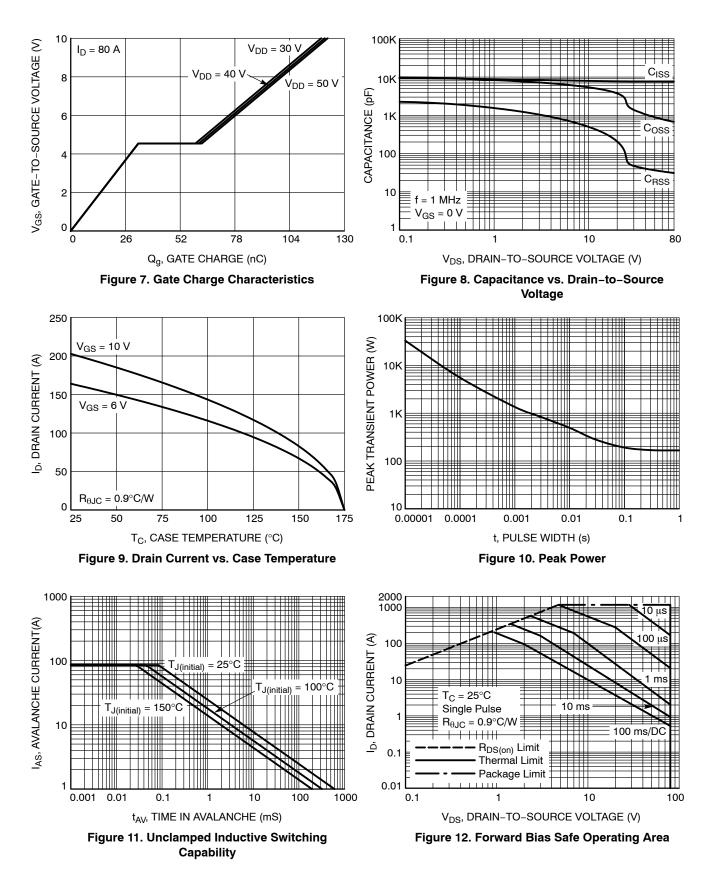
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Switching characteristics are independent of operating junction temperatures.

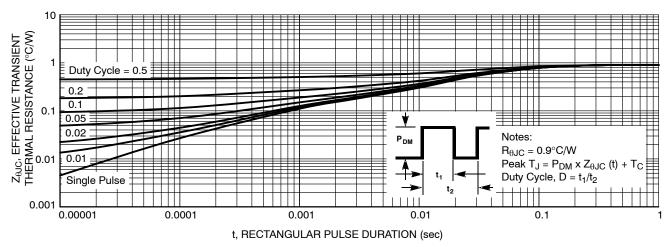
# **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**



# **TYPICAL CHARACTERISTICS**



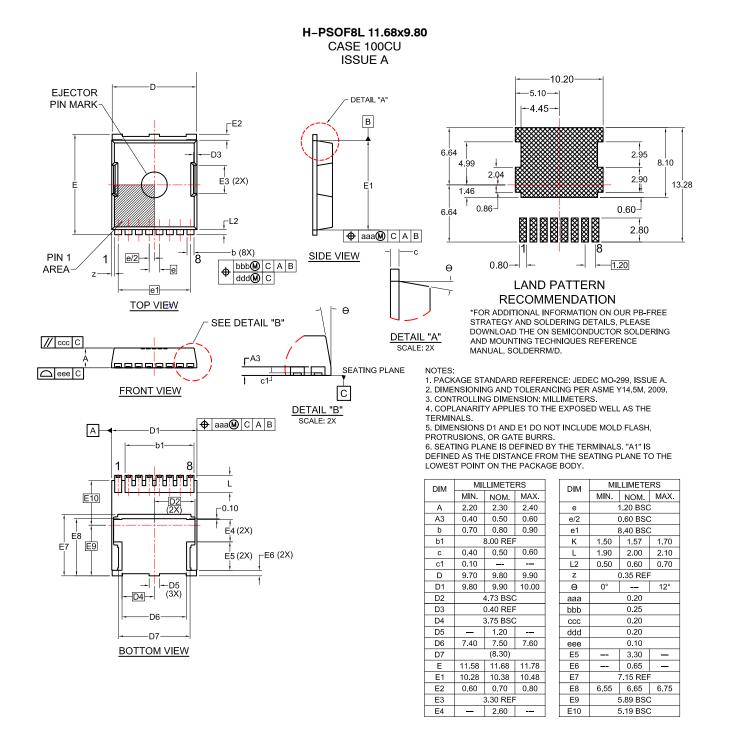
#### Figure 13. Transient Thermal Impedance

### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTBLS1D7N08H	1D7N08H	M0–299A (Pb–Free)	2000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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